

SIZE	QTY	SYM	PLATED	TOL
0.006	62	⊗	YES	+/-0.003
0.01	313	+	YES	+/-0.003
0.035	15	⊗	YES	+/-0.003
0.065	8	◇	YES	+/-0.003
0.094	6	+ ^A	YES	+/-0.003
0.07	2	□	NO	+/-0.003
0.187	4	⊗	NO	+/-0.003

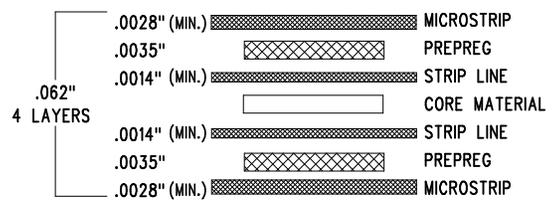
ADDITIONAL REQUIREMENT FOR PROTOTYPE FAB ONLY:

1. OUTGOING INSPECTION REPORT
(BASED ON ACTUAL MEASUREMENTS AND CROSS SECTION).

ADDITIONAL REQUIREMENTS FOR PRODUCTION FAB ONLY:

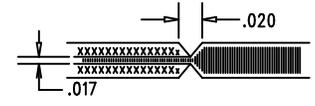
1. PROVIDE COMPLIANCE CERTIFICATES FOR RoHS, REACH AND CONFLICT-FREE MINERALS.
2. SOLDERABILITY BOARD WITH TEST RESULTS.
3. OUTGOING INSPECTION REPORT
(BASED ON ACTUAL MEASUREMENTS AND CROSS SECTION).
4. VACUUM PACKED WITH DESICCANT.
5. FULL PANEL WITH NO REJECT

LAYER STRUCTURE



NOTES: UNLESS OTHERWISE SPECIFIED

1. FAB PER IPC-A-600.
2. MATERIAL: -EPOXY FIBERGLASS, NEMA GRADE FR-4
-FINISHED THICKNESS TO BE 0.062" +/- .005"
-TOTAL OF 4 LAYERS WITH 2 OZ. CU ON THE OUTER LAYERS AND 1 OZ. CU ON THE INNER LAYERS.
-FLAMMABILITY RATING: 94 V-0 MINIMUM.
3. SIZE: CUT TO DIMENSIONS AND TOLERANCES SHOWN.
0.00" ARE PRIMARY DATUMS.
4. DRILLING: -DRILL HOLES PER SCHEDULE. PLATE THROUGH HOLES WITH COPPER, 0.001" THICK MIN.
-ALL HOLE SIZES ARE SPECIFIED AFTER PLATING.
-HOLE LOCATION TOLERANCES ARE +/-0.003" IN RELATION TO CENTER
-FOR VIAS SIZE LESS THAN 0.013", HOLES NEED TO BE PLUGGED AND COVERED WITH SOLDERMASK.
5. FINISH: -SMOBC USING LPI BOTH SIDES, COLOR GLOSS GREEN
-GOLD IMMERSION BOTH SIDES.
(LEAD FREE SOLDER CAN BE USED FOR PROTOTYPE)
-FOR SILKSCREEN: BOTH SIDES USE WHITE NON-CONDUCTIVE INK.
6. DO NOT ALTER ARTWORK e.g. TO ADD LOGO OR DATE CODE.
PAD SIZE CAN BE MODIFIED TO MEET END FINISH.
7. PCBs ARE TO BE RoHS COMPLIANT.
8. SCORING FOR PANELIZED PCB:



UNLESS OTHERWISE SPECIFIED
DIMENSIONS ARE IN INCHES
TOLERANCES:
0.XX" = ±0.01"
0.XXX" = ±0.005"
INTERPRET DIM AND TOL
PER ASME Y14.5M-1994
THIRD ANGLE PROJECTION

www.analog.com	
TITLE: FABRICATION DRAWING 60VIN, 100VOUT LOW EMI 4-SWITCH BUCK-BOOST LED CONTROLLER	
SIZE N/A	IC NO. LT8393JFE DC2865A
FILENAME:	REV 7 SHT 1 OF 1